- Contains Eight Flip-Flops With Single-Rail Outputs
- Buffered Clock and Direct Clear Inputs
- Individual Data Input to Each Flip-Flop
- Applications Include:

Buffer/Storage Registers Shift Registers Pattern Generators

description

These monolithic, positive-edge-triggered flipflops utilize TTL circuitry to implement D-type flip-flop logic with a direct clear input.

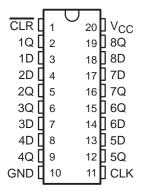
Information at the D inputs meeting the setup time requirements is transferred to the Q outputs on the positive-going edge of the clock pulse. Clock triggering occurs at a particular voltage level and is not directly related to the transition time of the positive-going pulse. When the clock input is at either the high or low level, the D input signal has no effect ar the output.

These flip-flops are guaranteed to respond to clock frequencies ranging form 0 to 30 megahertz while maximum clock frequency is typically 40 megahertz. Typical power dissipation is 39 milliwatts per flip-flop for the '273 and 10 milliwatts for the 'LS273.

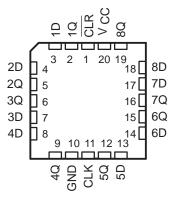
FUNCTION TABLE (each flip-flop)

ı	NPUTS		OUTPUT
CLEAR	CLOCK	D	Q
L	Х	Χ	L
н	\uparrow	Н	Н
н	\uparrow	L	L
Н	L	Χ	Q ₀

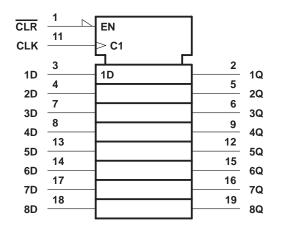
SN54273, SN74LS273 . . . J OR W PACKAGE SN74273 . . . N PACKAGE SN74LS273 . . . DW OR N PACKAGE (TOP VIEW)



SN54LS273 . . . FK PACKAGE (TOP VIEW)



logic symbol†

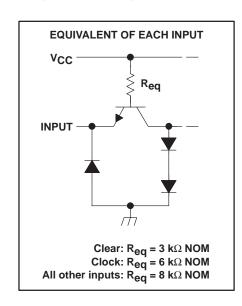


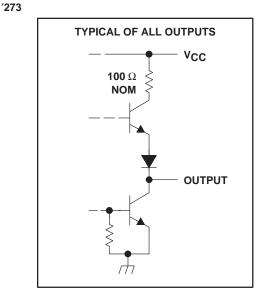
[†]This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

Pin numbers shown are for the DW, J, N, and W packages.



schematics of inputs and outputs



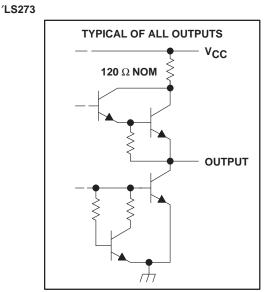


EQUIVALENT OF EACH INPUT

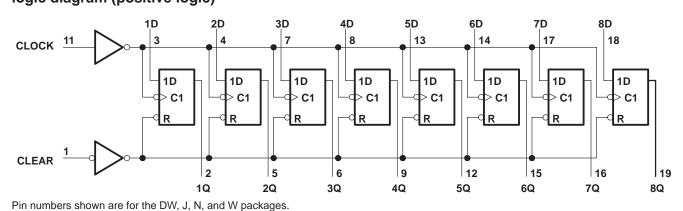
VCC

20 kΩ
NOM

INPUT



logic diagram (positive logic)





absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{CC} (see Note 1)	7 V
Input voltage	5.5 V
Operating free-air temperature range, T _A : SN54273	-55°C to 125°C
SN74273	0°C to 70°C
Storage temperature range	-65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

			SN54273			SN74273			
				MAX	MIN	NOM	MAX	UNIT	
Supply voltage, V _{CC}		4.5	5	5.5	4.75	5	5.25	V	
High-level output current, IOH				-800			-800	μΑ	
Low-level output current, IOL			16			16	mA		
Clock frequency, f _{clock}	0		30	0		30	MHz		
Width of clock or clear pulse, t _W		16.5			16.5			ns	
Sotup time +	Data input	20↑			20↑			20	
Setup time, t _{SU}	Clear inactive state	25↑			25↑			ns	
Data hold time, th					5↑			ns	
Operating free-air temperature, TA	Operating free-air temperature, T _A			125	0		70	°C	

[↑]The arrow indicates that the rising edge of the clock pulse is used for reference.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER		TEST C	ONDITIONS [†]	MIN	TYP‡	MAX	UNIT
VIH	High-level input voltage			2			V	
V _{IL}	Low-level input voltage						0.8	V
٧ıK	Input clamp voltage		V _{CC} = MIN,	$I_{I} = -12 \text{ mA}$			-1.5	V
Vон	High-level output voltage	V _{CC} = MIN, V _{IL} = 0.8 V,	$V_{IH} = 2 V$, $I_{OH} = -800 \mu A$	2.4	3.4		V	
V _{OL}	Low-level output voltage		V _{CC} = MIN, V _{IL} = 0.8 V,	V _{IH} = 2 V, I _{OH} = 16 mA			0.4	V
Ιį	Input current at maximum input voltag	је	V _{CC} = MAX,	V _I = 5.5 V			1	mA
l	High-level input current	Clear)/ BAAN/	V _I = 2.4 V			80	
liH	nigh-level input current	Clock or D	V _{CC} = MAX,	V = 2.4 V			40	μΑ
1	Low-level input current	Clear	VCC = MAX,	V _I = 0.4 V			-3.2	mA
ΊL	Low-level input current	Clock or D	VCC = IVIAX,	V = 0.4 V			-1.6	
los	Short-circuit output current§		V _{CC} = MAX		-18		-57	mA
Icc	Supply current		V _{CC} = MAX,	See Note 2		62	94	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 2: With all outputs open and 4.5 V applied to all data and clear inputs, I_{CC} is measured after a momentary ground, then 4.5 V, is applied to clock.



 $^{^\}ddagger$ All typical values are at V_{CC} = 5 V, T_A = 25°C.

[§] Not more than one output should be shorted at a time.

SN54273, SN54LS273, SN74273, SN74LS273 OCTAL D-TYPE FLIP-FLOP WITH CLEAR

SDLS090 - OCTOBER 1976 - REVISED MARCH 1988

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
fmax	Maximum clock frequency		30	40		MHz
tPHL	Propagation delay time, high-to-low-level output from clear	C _L = 15 pF,		18	27	ns
tPLH	Propagation delay time, low-to-high-level output from clock	R _L = 400 Ω , See Note 3		17	27	ns
tPHL	Propagation delay time, high-to-low-level output from clock			18	27	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{CC} (see Note 1)	7 V
Input voltage	7 V
Operating free-air temperature range, T _A : SN54LS273	. −55°C to 125°C
SN74LS273	0°C to 70°C
Storage temperature range	. −65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

					SN74LS273			UNIT
					MIN	NOM	MAX	UNII
Supply voltage, V _{CC}		4.5	5	5.5	4.75	5	5.25	V
High-level output current, IOH				-400			-400	μΑ
Low-level output current, IOL			4			8	mA	
Clock frequency, f _{clock}	0		30	0		30	MHz	
Width of clock or clear pulse, t _W		20			20			ns
Setup time t	Data input	20↑			20↑			20
Setup time, t _{SU}	Clear inactive state	25↑			25↑			ns
Data hold time, th	•	5↑			5↑			ns
Operating free-air temperature, TA	-	-55		125	0		70	°C

The arrow indicates that the rising edge of the clock pulse is used for reference.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEC	T CONDITION	uet	SI	N54LS27	'3	SI	N74LS27	'3	UNIT
	PARAMETER	153	I CONDITIO	151	MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNII
VIH	High-level input voltage				2			2			V
VIL	Low-level input voltage						0.7			0.8	V
VIK	Input clamp voltage	V _{CC} = MIN,	I _I = -18 mA				-1.5			-1.5	V
Vон	High-level output voltage	V _{CC} = MIN, V _{IL} = V _{IL} max,	$V_{IH} = 2 V,$ $I_{OH} = -400$	μΑ	2.5	3.4		2.7	3.4		V
\/o:	Low-level output voltage	V _{CC} = MIN,	V _{IH} = 2 V,	$I_{OL} = 4 \text{ mA}$		0.25	0.4		0.25	0.4	V
VOL	Low-level output voltage	V _I L = V _I Lmax,		$I_{OL} = 8 \text{ mA}$					0.35	0.5	V
lį	Input current at maximum input voltage	V _{CC} = MAX,	V _I = 7 V				0.1			0.1	mA
lн	High-level input current	$V_{CC} = MAX$,	V _I = 2.7 V				20			20	μΑ
I _{IL}	Low-level input current	$V_{CC} = MAX$,	V _I = 0.4 V				-0.4			-0.4	mA
los	Short-circuit output current§	V _{CC} = MAX			-20		-100	-20		-100	mA
ICC	Supply current	$V_{CC} = MAX$,	See Note 2			17	27		17	27	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 2: With all outputs open and 4.5 V applied to all data and clear inputs, I_{CC} is measured after a momentary ground, then 4.5 V, is applied to clock.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
f _{max}	Maximum clock frequency	_	30	40		MHz
tPHL	Propagation delay time, high-to-low-level output from clear	$C_L = 15 \text{ pF},$ $R_1 = 2 \text{ k}\Omega,$		18	27	ns
tPLH	Propagation delay time, low-to-high-level output from clock	See Note 3		17	27	ns
tPHL	Propagation delay time, high-to-low-level output from clock			18	27	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

[§] Not more than one output should be shorted at a time and duration of short circuit should not exceed one second.



TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS273DWR	SOIC	DW	20	2000	330.0	24.4	10.8	13.0	2.7	12.0	24.0	Q1
SN74LS273NSR	SO	NS	20	2000	330.0	24.4	8.2	13.0	2.5	12.0	24.0	Q1





*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS273DWR	SOIC	DW	20	2000	346.0	346.0	41.0
SN74LS273NSR	SO	NS	20	2000	346.0	346.0	41.0

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